

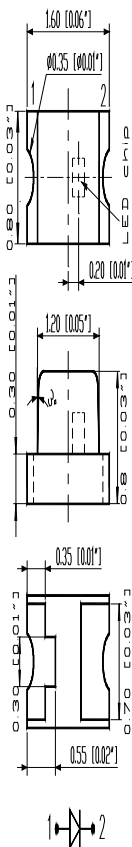
SURFACE MOUNT LED LAMPS

表面黏著型發光二極體指示燈

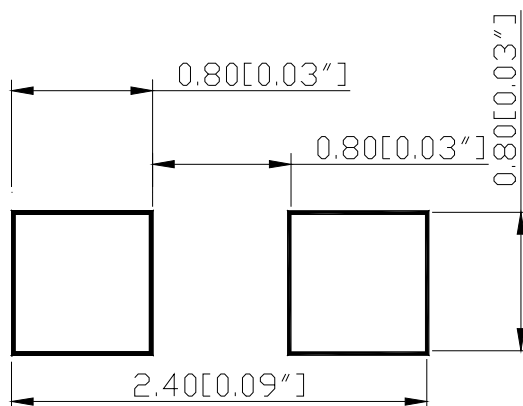
S190 Series SMD Chip LED Lamps

Part Number: 190UR

Package outlines



RECOMMEND PAD LAYOUT



ITEM	MATERIALS
Resin (mold)	Epoxy
Bonding wire	↓ 25 μm Au
Lens color	Water transparent
Printed circuit board	BT (White)
Dice	AlGaInP
Emitted color	Red



NOTES:

1. All dimensions are in millimeters (inches);
2. Tolerances are ±0.1mm (0.004inch) unless otherwise noted.

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Part Number: 190UR

Absolute maximum ratings (T_A=25°C)

Parameter	Symbol	Value	Unit
Forward current	I _f	30	mA
Reverse voltage	V _r	5	V
Power dissipation	P _d	75	mW
Operating temperature range	T _{op}	-20 ~+80	°C
Storage temperature range	T _{stg}	-20 ~+80	°C
Peak pulsing current (1/8 duty f=1kHz)	I _{fp}	125	mA

Electro-optical characteristics (T_A=25°C)

Parameter	Test Condition	Symbol	Value			Unit
			Min	Typ	Max	
Wavelength at peak emission	I _f =20mA	λ _{peak}	628	635	640	nm
Spectral half bandwidth	I _f =20mA	Δλ	--	20	--	nm
Dominant wavelength	I _f =20mA	λ _{dom}		630		nm
Forward voltage	I _f =20mA	V _f	--	2.0	2.3	V
Luminous intensity * 1	I _f =20mA	I _v	50	--	--	mcd
Viewing angle at 50% I _v	I _f =10mA	2θ _{1/2}	--	140	--	Deg
Reverse current	V _r =5V	I _r	--	--	10	μA

* 1 Note: Luminous intensity tolerance is ±10%.

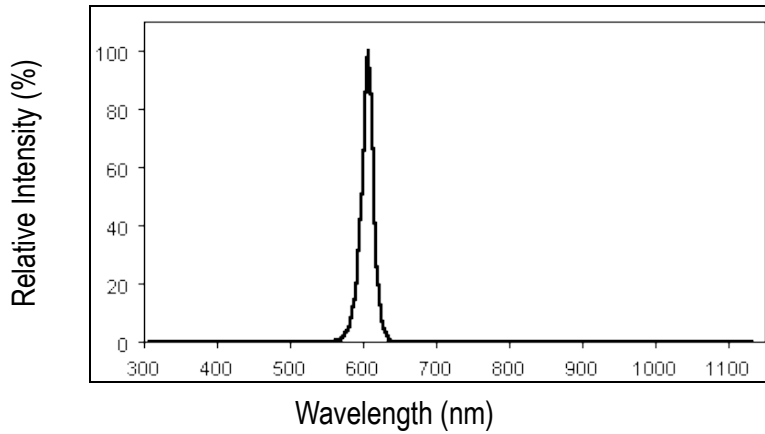
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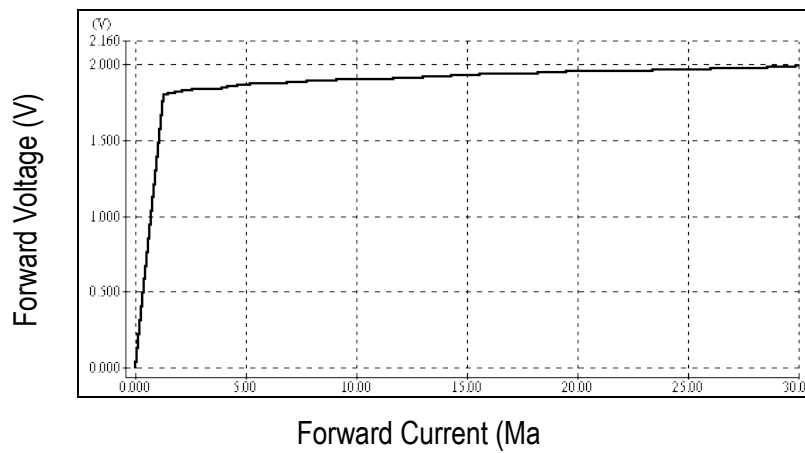
Part Number: Q190AIS

OPTICAL CHARACTERISTIC CURVES

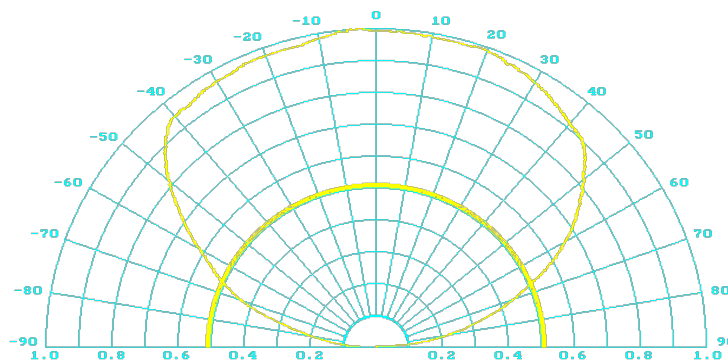
Relative Intensity vs. Wavelength



Forward Current vs. Forward Voltage



Directive Characteristics

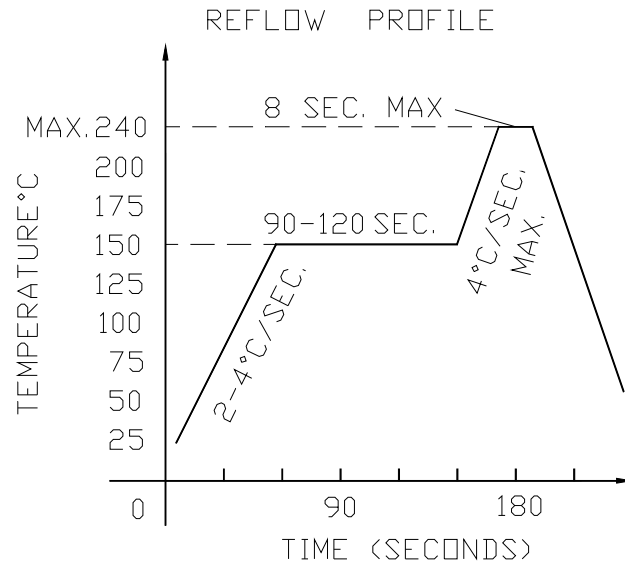


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Reflow Profile

■ Reflow Temp/Time

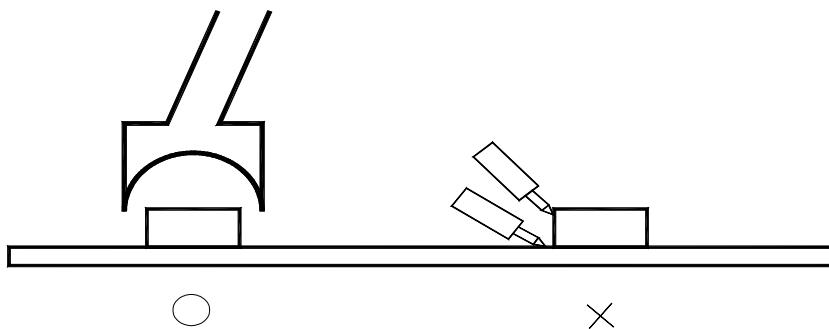


■ Soldering iron

Basic spec is $\leq 5\text{sec}$ when 260°C . If temperature is higher, time should be shorter ($+10^{\circ}\text{C} \rightarrow -1\text{sec}$). Power dissipation of iron should be smaller than 15W, and temperatures should be controllable. Surface temperature of the device should be under 230°C .

■ Rework

1. Customer must finish rework within 5 sec under 260°C .
2. The head of iron can not touch copper foil
3. Twin-head type is preferred.

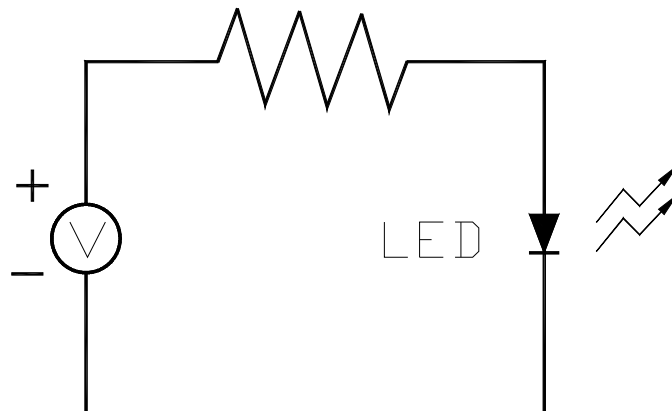


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Test circuit and handling precautions

■ Test circuit



■ Handling precautions

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2.Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature : 5°C~30°C(41°F~86°F)

2.2 Shelf life in sealed bag: 12 month at < 5°C~30°C and < 30% R.H. after the package is Opened, the products should be used within a week or they should be keeping to stored at ≤ 20 R.H. with zip-lock sealed.

3.Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

3.1 60±3°C x(12~24hrs) and < 5%RH, taped reel type

3.2 100±3°C x(45min~1hr), bulk type

3.3 130±3°C x(15~30min), bulk type

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Test items and results of reliability

Type	Test Item	Test Conditions	Note	Number of Damaged
Sequential	Temperature Cycle	-20°C 30min ↑↓ 80°C 30min	100 cycle	0/22
	Thermal Shock	-20°C 15min ↑↓ 80°C 15min	100 cycle	0/22
	High Humidity Heat Cycle	30°C ↔ 65°C 90%RH 24hrs/1cycle	10 cycle	0/22
	High Temperature Storage	T _a =80°C	1000 hrs	0/22
	Humidity Heat Storage	T _a =60°C RH=90%	1000 hrs	0/22
	Low Temperature Storage	T _a =-30°C	1000 hrs	0/22
Se@peration	Life Test	T _a =25°C I _F =20mA	1000 hrs	0/22
	High Humidity Heat Life Test	60°C RH=90% I _F =20mA	500 hrs	0/22
	Low Temperature Life Test	T _a =-20°C I _F =20mA	1000 hrs	0/22